

DESCRIPTION

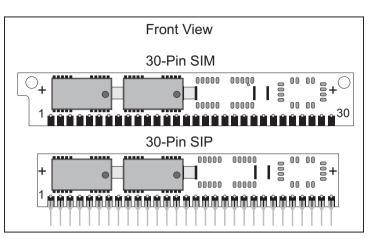
The Accutek AK58256AG/AS high density memory module is a random access memory organized in 256K x 8 bit words. The assembly consists of two 256K x 4 DRAMs in surface mount packages mounted to the front side of a printed circuit board. The module can be configured as a leadless 30 pad SIM or a leaded 30 pin SIP. This packaging approach provides a better than 6 to 1 density increase over standard DIP packaging.

The operation of the AK58256 is identical to two 256K x 4 DRAMs. The data input/output is brought out separately for each 256K x 4 device, with common RAS, CAS and WE control. The \overline{OE} pins are tied to Vss which dictates the use of early-write cycles to prevent contention of D and Q. Since the Write-Enable (WE) signal must always go low before CAS in a write cycle, Read-Write and Read-Modify-Write operation is not possible.

FEATURES

- 262,144 x 8 bit organization
- Optional 30 Pad leadless SIM (Single In-Line Module) or 30
 Pin leaded SIP (Single In-Line Package)
- JEDEC standard pinout
- Common \overline{CAS} , \overline{RAS} and \overline{WE} control for eight DQ lines
- Separate CAS control for one separate pair of D and Q lines
- 1024 refresh cycles/16ms, A₀ to A₈

AK58256AG / AK58256AS 262,144 x 8 bit CMOS Dynamic Random Access Memory



- Power: .99 Watt Max Active (60 nS) .88 Watt Max Active (70 nS) .77 Watt Max Active (80 nS) .65 Watt Max Active (100 nS) 11 mWatt standby (max)
- Operating free air temperature: 0⁰ to 70⁰C
- Upward compatible with AK581024, AK584096 and AK5816384
- Functionally and Pin compatible with AK48256
- · Available with access times of 60 to 100 nS

PIN NOMENCLATURE

DQ ₁ - DQ ₈	Data In / Data Out
A ₀ - A ₈	Address Inputs
CAS	Column Address Strobe
RAS	Row Address Strobe
WE	Write Enable
Vcc	5v Supply
Vss	Ground
NC	No Connect

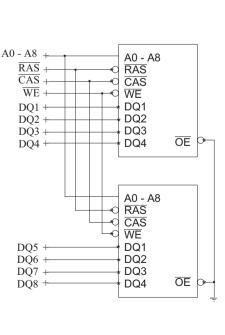
MODULE OPTIONS

Leadless SIM: AK58256AS
Leaded SIP: AK58256AG

PIN ASSIGNMENT

FUNCTIONAL DIAGRAM





ORDERING INFORMATION

	ART NUMBER CODING INTERI	1	2	3	4	5	6	7
1	Product AK = Accutek Memory							
2	Type 4 = Dynamic RAM 5 = CMOS Dynamic RAM 6 = Static RAM							
3	Organization/Word Width 1 = by 1 16 = by 16 4 = by 4 32 = by 32 8 = by 8 36 = by 36 9 = by 9							
4	Size/Bits Depth 64 = 64K 4096 = 4 MEG 256 = 256K 8192 = 8 MEG 1024 = 1 MEG 16384 = 16 MEG							
5	Package Type G = Single In-Line Package (SIP) S = Single In-Line Module (SIM) D = Dual In-Line Package (DIP) W = .050 inch Pitch Edge Connect Z = Zig-Zag In-Line Package (ZIP)							
5	Special Designation P = Page Mode N = Nibble Mode K = Static Column Mode W = Write Per Bit Mode V = Video Ram							
7	Separator - = Commercial 0 ⁰ C to +70 ⁰ C							
	M = Military Equivalent Screened (-550C to +1250C) I = Industrial Temperature Tested (-450C to +850C) X = Burned In							
8	Speed (first two significant digits)DRAMSSRAMS $60 = 60 \text{ nS}$ $8 = 8 \text{ nS}$ $70 = 70 \text{ nS}$ $12 = 12 \text{ nS}$ $80 = 80 \text{ nS}$ $15 = 15 \text{ nS}$ $10 = 100 \text{ nS}$ $20 = 20 \text{ nS}$							

10 = 100 nS 20 = 20 nS 12 = 120 nS 70 = 70 nS 15 = 150 nS 85 = 85 nS

The numbers and coding on this page do not include all variations available, but are shown as examples of the most widely used variations. Contact Accutek if other information is required.

EXAMPLES:

AK58256ASP-60

256K x 8, Dynamic RAM, Leadless SIM, Page Mode, Commercial, 60 nSEC Access Time

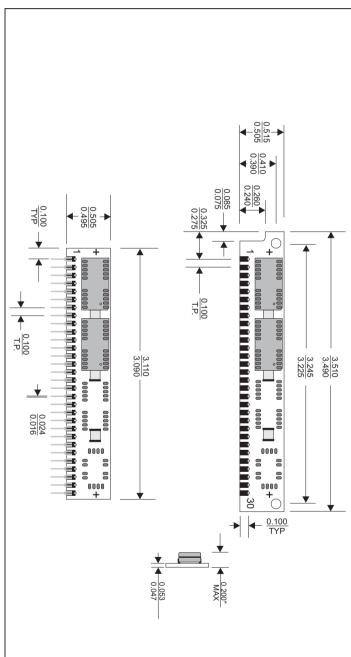
AK58256AGK-70

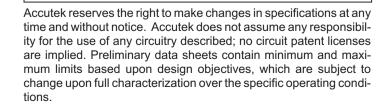
256K x 8, Dynamic RAM, Leaded SIP, Static Column Mode Commercial, 70 nSEC AccessTime

MECHANICAL DIMENSIONS

Inches

8







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